	E502650

50 Amp Bridge Rectifiers 1600 Volts

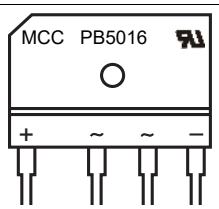
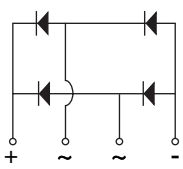
Features

- Halogen Free. “Green” Device (Note 1)
- Glass Passivated Chip Junction
- Superior Thermal Conductivity
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant (Note 2)("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings @ 25°C (Unless Otherwise Specified)

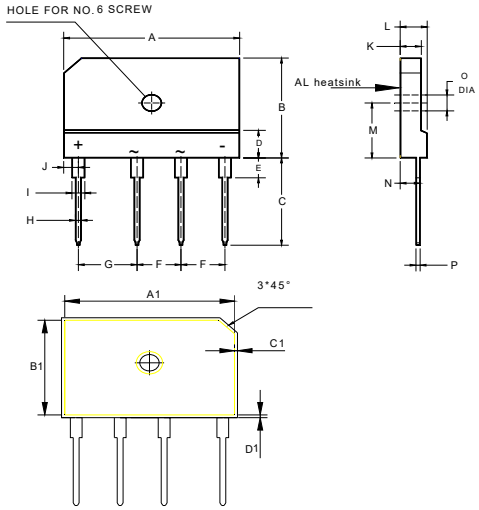
Parameter	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	1600	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R		
RMS Reverse Voltage	V_{RMS}	1120	V
Average Rectified Forward Current @ T_C=110°C (With Heatsink)	$I_{F(AV)}$	50	A
Average Rectified Forward Current @ T_A=25°C (Without Heatsink)		4.5	
Non-Repetitive Peak Surge Current @ 8.3ms Half Sine Wave	I_{FSM}	500	A
Non-Repetitive Peak Surge Current @ 1ms Square Wave		1000	
I^2t Rating for Fusing @1ms≤t≤8.3ms	I^2t	1037.5	A^2s
Dielectric strength @Terminals to Case, AC 1 Minute	V_{dis}	2.5	KV

Internal Structure

Simplified Outline	Graphic Symbol
	

Note:
1.Halogen free "Green” products are defined as those which contain <900ppm bromin <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. High Temperature Solder Exemption Applied, see EU Directive Annex 7a

PB



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	1.169	1.193	29.70	30.30	
B	0.776	0.799	19.70	20.30	
C	0.669	0.709	17.00	18.00	
D	0.189	0.228	4.80	5.80	
E	0.150	0.165	3.80	4.20	
F	0.287	0.303	7.30	7.70	
G	0.386	0.402	9.80	10.20	
H	0.035	0.043	0.90	1.10	
I	0.079	0.094	2.00	2.40	
J	0.091	0.106	2.30	2.70	
K	0.134	0.150	3.40	3.80	
L	0.173	0.189	4.40	4.80	
M	0.425	0.441	10.80	11.20	
N	0.122	0.146	3.10	3.70	
O	0.122	0.134	3.10	3.40	
P	0.024	0.031	0.60	0.80	
A1	1.136	1.144	28.85	29.05	
B1	0.742	0.750	18.85	19.05	
C1	0.016	0.024	0.40	0.60	
D1	0.016	0.024	0.40	0.60	

Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_J	Operating Junction Temperature Range		-55		150	°C
T_{stg}	Storage Temperature Range		-55		150	°C
$Rth_{(J-C)}$	Thermal Resistance from Junction to Case	Note 1		0.7		°C/W
$Rth_{(J-A)}$	Thermal Resistance from Junction to Ambient	Without Heatsink		18		°C/W

Note:
1.Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

Mechanical Data

Recommended Mounting Torque: 5 in·lbs

Electrical Characteristics @ 25°C Unless Otherwise Specified(Per Diode)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Forward Voltage	V_F	I_F=25A;T_J=25°C			1.1	V
Reverse Current	I_R	at Rated V_R;T_J=25°C at Rated V_R;T_J=125°C			5 1000	μA
Junction Capacitance	C_J	V_R=4V;f=1MHz;T_J=25°C		195		pF

Curve Characteristics

Fig. 1 - Forward Current Derating Curve

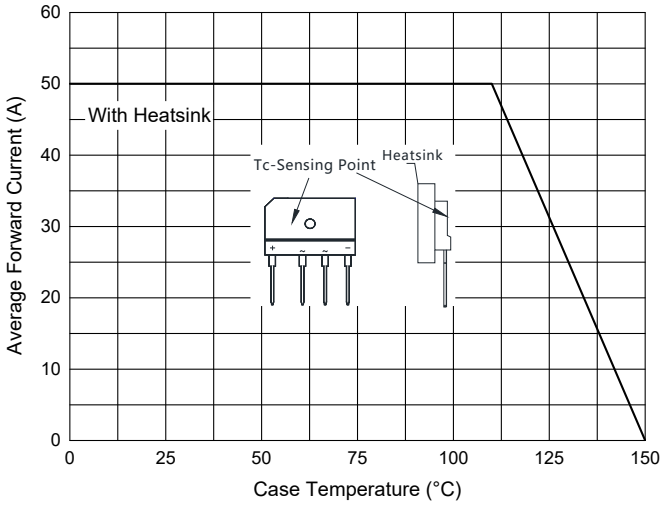


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current(Per Diode)

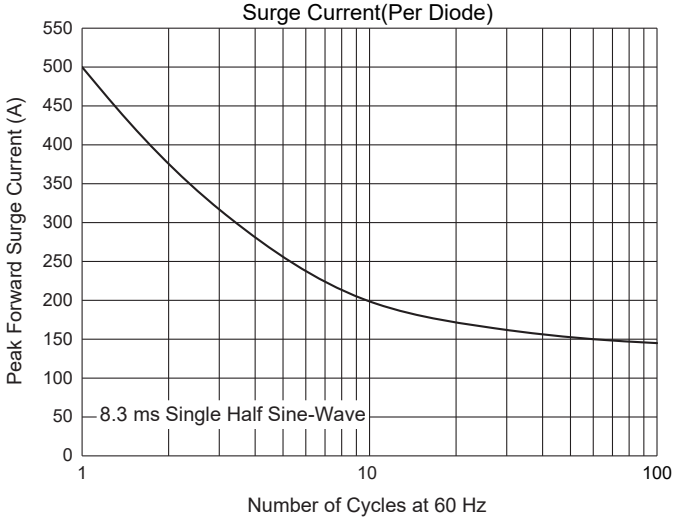


Fig. 3 - Typical Forward Characteristics (Per Diode)

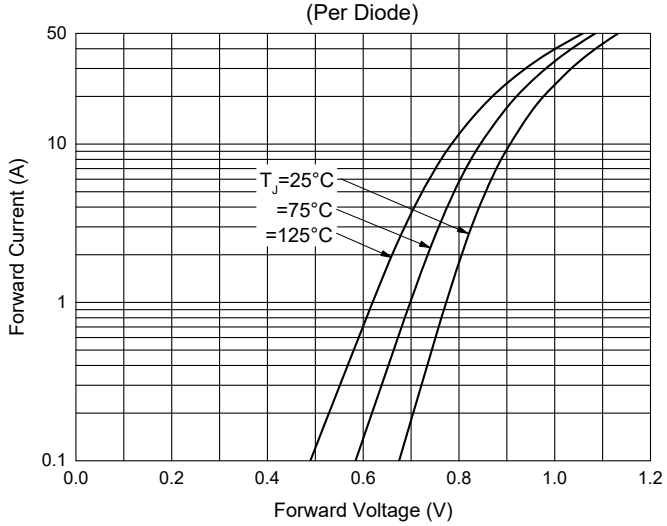


Fig. 4 - Typical Reverse Leakage Characteristics (Per Diode)

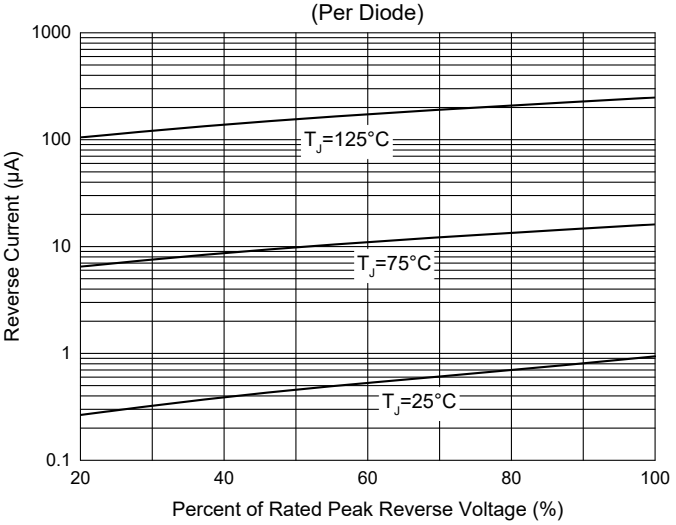
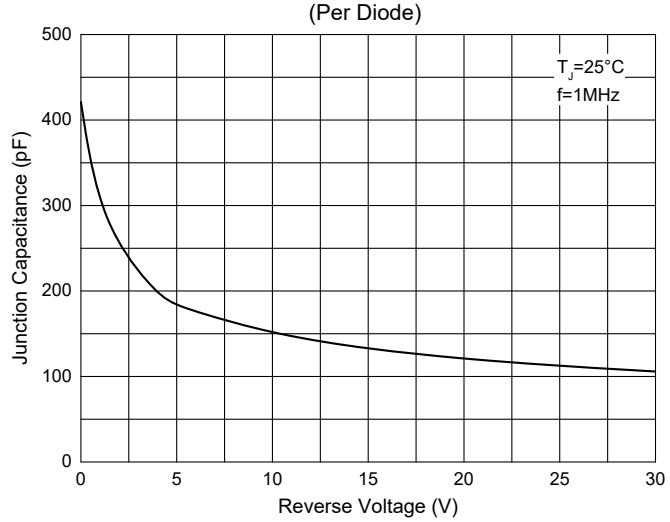


Fig. 5 - Typical Capacitance Characteristics (Per Diode)



Ordering Information

Device	Packing
PB5016-BP	Bulk:15pcs/Tube,750pcs/Box,1500pcs/Carton